Special Issue

BIM and Its Integration with Emerging Technologies

Message from the Guest Editors

Building information modeling (BIM) has quickly attracted attention in the construction industry due to its promising benefits and has become the key technology affecting all phases of construction projects (i.e., design, construction, operation), BIM also offers a great potential to significantly enhance project performances through its integration with other emerging technologies, such as virtual reality (VR) for improved design inspection, laser scanning for capturing as-built conditions, unmanned aerial vehicles (UAVs) for automated progress monitoring, design for manufacture and assembly (DFMA) for improved productivity, and the Internet of Things (IOT) for post-occupancy evaluation. This Special Issue invites you to submit a manuscript on all related topics in the form of reviews and original research papers. Topics include but are not limited to the examples addressed above.

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Deadline for manuscript submissions

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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